

ON Semiconductor®

FQB8N60C / FQI8N60C

N-Channel QFET® MOSFET

600 V, 7.5 A, 1.2 Ω

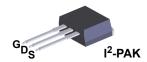
Description

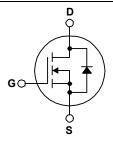
This N-Channel enhancement mode power MOSFET is • Low Gate Charge (Typ. 28 nC) produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • 100% Avalanche Tested resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 7.5 A, 600 V, $R_{DS(on)}$ = 1.2 Ω (Max.) @ V_{GS} = 10 V, $I_D = 3.75 A$
- Low Crss (Typ. 12 pF)
- · RoHS Compliant







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQB8N60CTM / FQI8N60CTU	Unit
V _{DSS}	Drain-Source Voltage		600	V
I _D	Drain Current - Continuous (T _C = 25°C)		7.5	Α
	- Continuous (T _C = 100°C)		4.6	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	30	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	230	mJ
I _{AR}	Avalanche Current	(Note 1)	7.5	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	14.7	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
	Power Dissipation (T _A = 25°C)*		3.13	W
P_{D}	Power Dissipation (T _C = 25°C)		147	W
	- Derate above 25°C		1.18	W/°C
T_J , T_{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds.		300	°C

Thermal Characteristics

Symbol	Parameter	FQB8N60CTM / FQI8N60CTU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.85	
В	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40	

Package Marking and Ordering Information

Parameter

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQB8N60CTM	FQB8N60C	D ² -PAK	Tape and Reel	330 mm	24 mm	800 units
FQI8N60CTU	FQI8N60C	I ² -PAK	Tube	N/A	N/A	50 units

Test Conditions

Min.

Тур.

Max.

Unit

Electrical Characteristics

Symbol

T_C = 25°C unless otherwise noted.

BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	600			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		0.7		V/°C
I _{DSS} Z	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 480 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 3.75 \text{ A}$		1.0	1.2	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 40 \text{ V}, I_{D} = 3.75 \text{ A}$		8.7		S

Dynamic Characteristics

C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$	 965	1255	pF
Coss	Output Capacitance	f = 1.0 MHz	 105	135	pF
C _{rss}	Reverse Transfer Capacitance		 12	16	pF

Switching Characteristics

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 300 \text{ V, } I_D = 7.5 \text{A,}$	 16.5	45	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$	 60.5	130	ns
t _{d(off)}	Turn-Off Delay Time		 81	170	ns
t _f	Turn-Off Fall Time	(Note 4)	 64.5	140	ns
Q_g	Total Gate Charge	$V_{DS} = 480 \text{ V}, I_{D} = 7.5 \text{A},$	 28	36	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 10 V	 4.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4)	 12		nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current		 	7.5	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		 	30	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 7.5 \text{ A}$	 	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 7.5 \text{ A},$	 365		ns
Q _{rr}	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$	 3.4		μС

Notes: 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2.L = 7.3 mH, I_{AS} = 7.5 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C. 3. $I_{SD} \le 7.5$ A, di/dt ≤ 200 A/ μ s , $V_{DD} \le BV_{DSS}$, starting T_{J} = 25°C. 4. Essentially independent of operating temperature.

Typical Characteristics

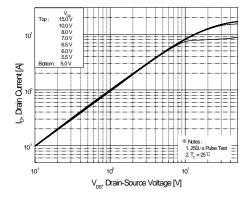


Figure 1. On-Region Characteristics

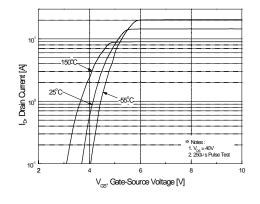


Figure 2. Transfer Characteristics

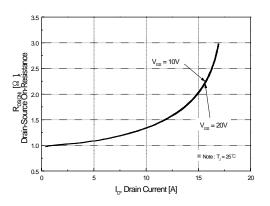


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

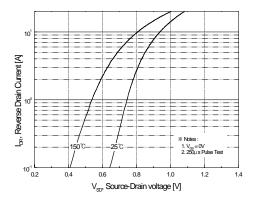


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

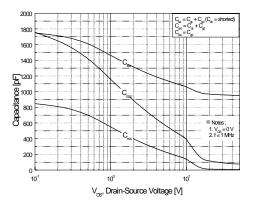


Figure 5. Capacitance Characteristics

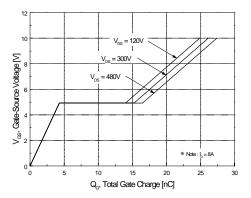
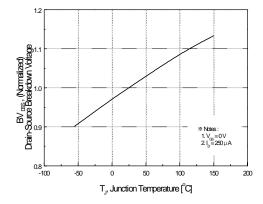


Figure 6. Gate Charge Characteristics

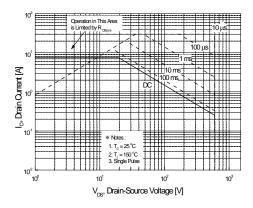
Typical Characteristics (Continued)



30 25 20 20 25 20 20 20 20 20 20 20 20 20

Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



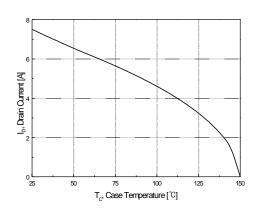


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

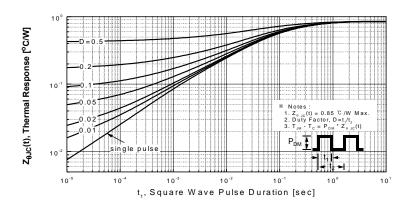


Figure 11. Transient Thermal Response Curve

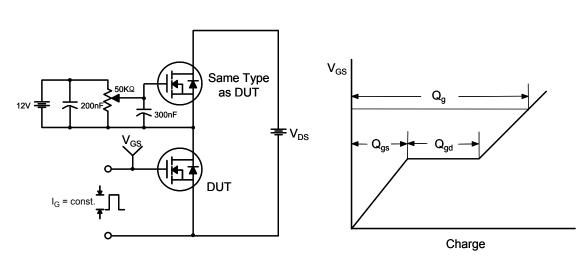


Figure 12. Gate Charge Test Circuit & Waveform

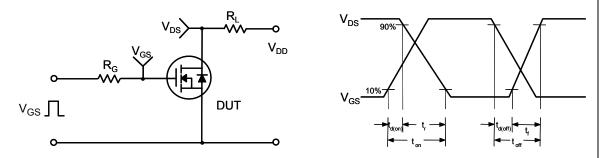


Figure 13. Resistive Switching Test Circuit & Waveforms

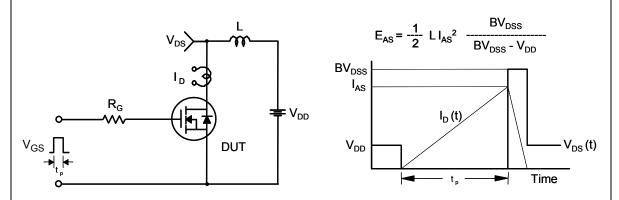
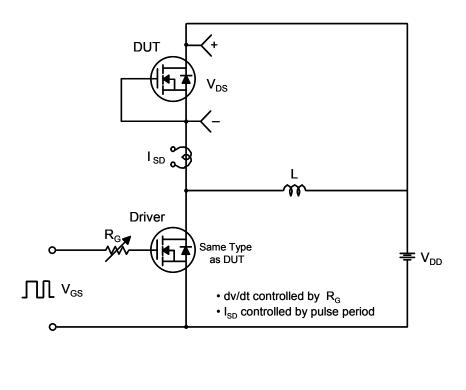


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



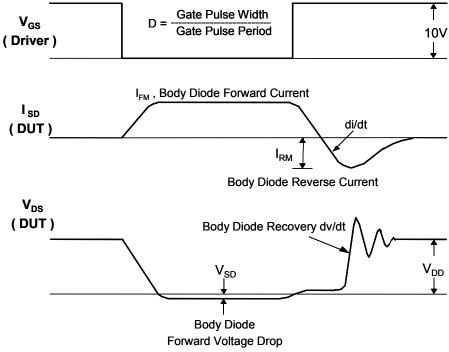


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

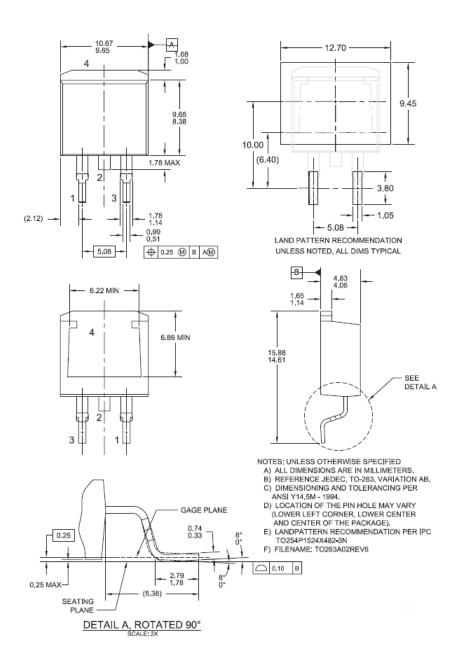
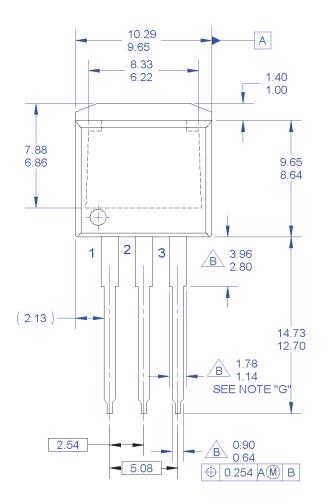
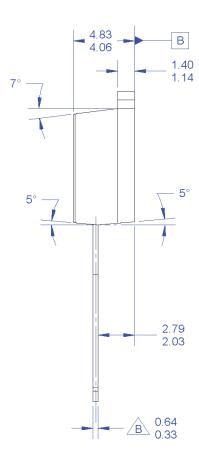


Figure 16. TO263 (D²PAK), Molded, 2-Lead, Surface Mount

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Mechanical Dimensions





NOTES:

- A. EXCEPT WHERE NOTED CONFORMS TO
 T0262 JEDEC VARIATION AA.
 B. DOES NOT COMPLY JEDEC STD. VALUE.
 C. ALL DIMENSIONS ARE IN MILLIMETERS.
 D. DIMENSIONS ARE EXCLUSIVE OF BURRS,
 MOLD FLASH AND TIE BAR PROTRINSIONS.
- E. DIMENSION AND TOLERANCE AS PER ANSI
- F. LOCATION OF PIN HOLE MAY VARY
 (LOWER LEFT CORNER, LOWER CENTER
 AND CENTER OF PACKAGE)
 G. MAXIMUM WIDTH FOR F102 DEVICE = 1.35 MAX.
 H. DRAWING FILE NAME: TO262A03REV5

Figure 17. TO262 (I²PAK), Molded, 3-Lead, Jedec Variation AA

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